TSMC 16/12: 3.3V GPIO



Libraries

Name	Process	Form Factor
RGO_TSMC16_18V33_FFC_20C	FFC	Staggered CUP
RGO_TSMC16_18V33_FFC_45C	FFC	Inline CUP
RGO_TSMC12_18V33_FFC_LL_20C	FFC_LL	Staggered CUP
RGO_TSMC12_18V33_FFC_LL_45C	FFC_LL	Inline CUP

Summary

The 3.3V GPIO library provides general purpose bidirectional I/O cells. These programmable, multi-voltage I/O's give the system designer the flexibility to design to a wide range of performance targets.

These libraries are offered at both 16nm and a 12nm shrink. They are available in inline and staggered CUP wire bond implementations with a flip chip option.

To design a functional I/O power domain with these cells, an additional library is required – 3.3V Support: Power. That library contains an input-only buffer, isolated analog I/O, and a full complement of power cells along with corner and spacer cells to assemble a complete pad ring by abutment. An included rail splitter allows multiple power domains to be isolated in the same pad ring while maintaining continuous VDD/VSS for robust ESD protection.

ESD Protection:

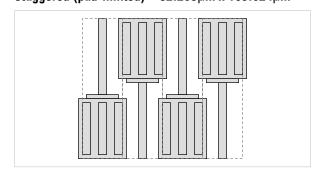
- JEDEC compliant
 - 2KV ESD Human Body Model (HBM)
 - o 500 V ESD Charge Device Model (CDM)

Latch-up Immunity:

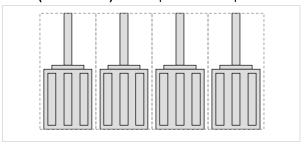
- JEDEC compliant
 - Tested to I-Test criteria of ± 100mA @ 125°C

Cell Size & Form Factor

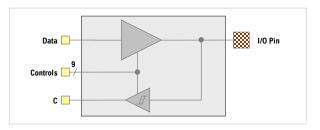
Staggered (pad-limited) - 32.208µm x 165.024µm



Inline (core-limited) – 45.12 μ m x 117.264 μ m



SRP_BI_SDS_1833V_STB



Bidirectional GPIO Driver Features

- Multi-Voltage (1.2V, 1.8V, 2.5V, 3.3V)
- LVCMOS / LVTTL input with selectable hysteresis
- Programmable drive strength (rated 2mA to 12mA)
- Selectable output slew rate
- Optimized for EMC with SSO factor of 8
- Open-drain output mode
- Programmable input options (pull-up/pull-down/repeater)
- Power-On Start (POS) capable
- Power sequencing independent design with Power-On Control

In full-drive mode, this driver can operate to frequencies in excess of 100MHz with 15pF external load and 125 MHz with 10pF load. Actual frequency limits are load and system dependent. A maximum of 200 MHz can be achieved under small capacitive loads.

Vertical-only (_V) and and horizontal-only (_H) variants provided.

Recommended operating conditions

	Description	Min	Nom	Max	Units
V_{VDD}	Core supply voltage	0.72	0.80	0.88	V
V _{DVDD}	I/O supply voltage	2.97	3.3	3.63	V
		2.25	2.5	2.75	V
		1.62	1.8	1.98	V
		1.08	1.2	1.32	V
TJ	Junction temperature	-40	25	125	°C
V_{PAD}	Voltage at PAD	V _{DVSS} -0.3	-	V _{DVDD} +0.3	V

TSMC 16/12: 3.3V GPIO



Characterization Corners (16nm)

Model	LPE Type	VDD=0.8V	DVDD [1]	Temp
FFGNP	Cbest_CCbest_T	+10%	+10%	-40°C
FFGNP	Cbest_CCbest_T	+10%	+10%	0°C
FFGNP	Cbest_CCbest_T	+10%	+10%	125°C
FFG	Ctypical	+10%	+10%	125°C
TT	Ctypical	nominal	nominal	25°C
TT	Ctypical	nominal	nominal	85°C
SSGNP	Cworst_CCworst_T	-10%	-10%	-40°C
SSGNP	Cworst_CCworst_T	-10%	-10%	0°C
SSGNP	Cworst_CCworst_T	-10%	-10%	125°C

[1] DVDD = 1.2V, 1.8V, 2.5V & 3.3V

Characterization Corners (12nm)

Model	LPE Type	VDD=0.8V	DVDD [1]	Temp
FF	Cbest_CCbest	+10%	+10%	-40°C
FF	Cbest_CCbest	+10%	+10%	0°C
FF	Cbest_CCbest	+10%	+10%	125°C
FFG	Ctypical	+10%	+10%	125°C
TT	Ctypical	nominal	nominal	25°C
TT	Ctypical	nominal	nominal	85°C
SS	Cworst_CCworst	-10%	-10%	-40°C
SS	Cworst_CCworst	-10%	-10%	0°C
SS	Cworst_CCworst	-10%	-10%	125°C

[1] DVDD = 1.2V, 1.8V, 2.5V & 3.3V

© 2011-2018 Aragio Solutions. All rights reserved.

Information in this document is subject to change without notice. Aragio Solutions may have patents, patent applications, trademarks, copyrights or other intellectual property rights covering subject matter in this document. Except as expressly provided in any written license agreement from Aragio, the furnishing of this document does not give you any license to the patents, trademarks, copyrights, or other intellectual property.

Published by:

Aragio Solutions
2201 K Avenue
Section B Suite 200
Plano, TX 75074-5918
Phone: (972) 516-0999
Fax: (972) 516-0998
Web: http://www.aragio.com/

While every precaution has been taken in the preparation of this book, the publisher assumes no responsibility for errors or omissions, or for damages resulting from the use of the information contained herein. This document may be reproduced and distributed in whole, in any medium, physical or electronic, under the terms of a license or nondisclosure agreement with Aragio.

Printed in the United States of America